

Title (en)
HEAT-TRANSFER DEVICE

Title (de)
WÄRMEÜBERTRAGUNGSVORRICHTUNG

Title (fr)
DISPOSITIF DE TRANSFERT DE CHALEUR

Publication
EP 4053487 A1 20220907 (EN)

Application
EP 21159906 A 20210301

Priority
EP 21159906 A 20210301

Abstract (en)
A heat-transfer device (100) comprises an evaporator (104) and a condenser (106) with at least one fluid-guide (102) to passively guide condensate (200) in a direction of the evaporator (104), wherein the fluid-guide (102) has at least one guide-structure (114) protruding from a condenser wall (108) of the condenser (106).

IPC 8 full level
F28D 15/02 (2006.01); **F28D 15/04** (2006.01)

CPC (source: EP)
F28D 15/0233 (2013.01); **F28D 15/025** (2013.01); **F28D 15/046** (2013.01); **F28D 2015/0216** (2013.01)

Citation (search report)

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Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)
BA ME

DOCDB simple family (publication)
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DOCDB simple family (application)
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